

ESD SMD Comm COG, Ceramic, 0.047 uF, 1%, 63 VDC, COG, SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I, 1206



Dimensions	
Chip Size	1206
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
T	1.6mm +/-0.20mm
B	0.6mm +/-0.25mm

Packaging Specifications	
Packaging:	T&R, 330mm, Plastic Tape
Packaging Quantity:	8000

General Information	
Series:	ESD SMD Comm COG
Style:	SMD Chip
Description:	SMD, MLCC, Temperature Stable, Electro Static Discharge, Class I
Features:	Temperature Stable, Low ESR, Class I
RoHS:	Yes
Termination:	Flexible Termination
Marking:	No
AEC-Q200:	No
Component Weight:	36 mg
Shelf Life:	78 Weeks
MSL:	1

Specifications	
Capacitance:	0.047 uF
Measurement Condition:	1 kHz 1.0Vrms
Capacitance Tolerance:	1%
Voltage DC:	63 VDC
ESD Level per AEC-Q200:	25,000 V ESD Level
Dielectric Withstanding Voltage:	157.5 VDC
Temperature Range:	-55/+125°C
Temperature Coefficient:	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor:	0.1% 1 kHz 1.0Vrms
Aging Rate:	0% Loss/Decade Hour
Insulation Resistance:	21.2766 GOhms

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